SDAS006B - APRIL 1982 - REVISED DECEMBER 1994

 Package Options Include Plastic Small-Outline (D) Packages, Ceramic Chip Carriers (FK), and Standard Plastic (N) and Ceramic (J) 300-mil DIPs

description

These devices contain four independent 2-input exclusive-OR gates. They perform the Boolean functions $Y = A \oplus B$ or $Y = \overline{AB} + A\overline{B}$ in positive logic.

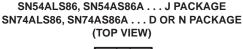
A common application is as a true/complement element. If one of the inputs is low, the other input is reproduced in true form at the output. If one of the inputs is high, the signal on the other input is reproduced inverted at the output.

The SN54ALS86 and SN54AS86A are characterized for operation over the full military temperature range of -55° C to 125° C. The SN74ALS86 and SN74AS86A are characterized for operation from 0°C to 70°C.

FUNCTION TABLE	
(each gate)	

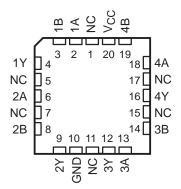
INP	UTS	OUTPUT
Α	В	Y
L	L	L
L	Н	н
н	L	н
Н	Н	L

logic symbol[†]

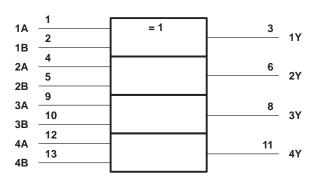


1A 1B 1Y	2	14 13 12	V _{CC} 4B 4A
2A	4	11]4Y
2B		10] 3B
2Y		9] 3A
GND	7	8]3Y

SN54ALS86, SN54AS86A . . . FK PACKAGE (TOP VIEW)



NC - No internal connection



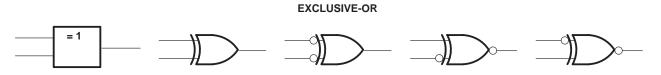
[†] This symbol is in accordance with ANSI/IEEE Std 91-1984 and IEC Publication 617-12. Pin numbers shown are for the D, J, and N packages.

PRODUCTION DATA information is current as of publication date. Products conform to specifications per the terms of Texas Instruments standard warranty. Production processing does not necessarily include testing of all parameters.

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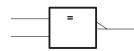
exclusive-OR logic

An exclusive-OR gate has many applications, some of which can be represented better by alternative logic symbols.



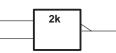
These are five equivalent exclusive-OR symbols valid for an 'ALS86 or 'AS86A gate in positive logic. Negation may be shown at any two ports.

LOGIC-IDENTITY ELEMENT



The output is active (low) if all inputs are at the same logic level (i.e., A = B).

EVEN-PARITY ELEMENT



The output is active (low) if an even number of inputs (i.e., 0 or 2) are active.

ODD-PARITY ELEMENT



The output is active (high) if an odd number of inputs (i.e., only 1 of the 2) are active.



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absolute maximum ratings over operating free-air temperature range (unless otherwise noted)[†]

Supply voltage, V _{CC}	
Operating free-air temperature range, T _A : SN54ALS86	
SN74ALS86	0°C to 70°C
Storage temperature range	-65°C to 150°C

[†] Stresses beyond those listed under "absolute maximum ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated under "recommended operating conditions" is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.

recommended operating conditions

		SN54ALS86			SN	UNIT		
		MIN	NOM	MAX	MIN	NOM	MAX	UNIT
VCC	Supply voltage	4.5	5	5.5	4.5	5	5.5	V
VIH	High-level input voltage	2			2			V
VIL	Low-level input voltage			0.7			0.8	V
ЮН	High-level output current			-0.4			-0.4	mA
IOL	Low-level output current			4			8	mA
TA	Operating free-air temperature	-55		125	0		70	°C

electrical characteristics over recommended operating free-air temperature range (unless otherwise noted)

PARAMETER	TEST	ONDITIONS	SN	154ALS8	86	SN	174ALS8	6	UNIT
PARAMETER	IESI C	UNDITIONS	MIN	MIN TYP [‡] MAX			MIN TYP [‡] MAX		
VIK	V _{CC} = 4.5 V,	lı = -18 mA			-1.5			-1.5	V
VOH	V _{CC} = 4.5 V to 5.5 V,	$I_{OH} = -0.4 \text{ mA}$	V _{CC} -2	2		V _{CC} -2	2		V
Vol	V _{CC} = 4.5 V	I _{OL} = 4 mA		0.25	0.4		0.25	0.4	V
VOL	VCC = 4.5 V	I _{OL} = 8 mA					0.35	0.5	v
lj	V _{CC} = 5.5 V,	V _I = 7 V			0.1			0.1	mA
ЧΗ	V _{CC} = 5.5 V,	VI = 2.7 V			20			20	μA
۱ _{IL}	$V_{CC} = 5.5 V,$	$V_{ } = 0.4 V$			-0.1			-0.1	mA
۱ _О §	V _{CC} = 5.5 V,	V _O = 2.25 V	-20		-112	-30		-112	mA
ICC	V _{CC} = 5.5 V,	All inputs at 4.5 V		3.9	5.9		3.9	5.9	mA

[‡] All typical values are at $V_{CC} = 5 \text{ V}$, $T_A = 25^{\circ}\text{C}$.

§ The output conditions have been chosen to produce a current that closely approximates one half of the true short-circuit output current, IOS.

switching characteristics (see Figure 1)

PARAMETER	TER FROM TO (INPUT) (OUTPUT)		CL RL	= 50 pF = 500 Ω		V,	UNIT
			SN54ALS86		SN74ALS86		
				MAX	MIN	MAX	
^t PLH	A or B	v v	3	22	3	17	20
^t PHL	(other input low)	T T	2	14	2	12	ns
tPLH	A or B	v	3	22	3	17	
tPHL	(other input high)	T	2	12	2	10	ns

 \P For conditions shown as MIN or MAX, use the appropriate value specified under recommended operating conditions.



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absolute maximum ratings over operating free-air temperature range (unless otherwise noted)[†]

Supply voltage, V _{CC}	
Input voltage, V _I	/V
Operating free-air temperature range, T _A : SN54AS86A	-55°C to 125°C
SN74AS86A	0°C to 70°C
Storage temperature range	-65°C to 150°C

[†] Stresses beyond those listed under "absolute maximum ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated under "recommended operating conditions" is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.

recommended operating conditions

		SN54AS86A			SN	UNIT		
		MIN	NOM	MAX	MIN	NOM	MAX	UNIT
VCC	Supply voltage	4.5	5	5.5	4.5	5	5.5	V
VIH	High-level input voltage	2			2			V
VIL	Low-level input voltage			0.8			0.8	V
ЮН	High-level output current			-2			-2	mA
IOL	Low-level output current			20			20	mA
TA	Operating free-air temperature	-55		125	0		70	°C

electrical characteristics over recommended operating free-air temperature range (unless otherwise noted)

PARAMETER	TECT	CONDITIONS	SN	54AS86	A	SN	174AS86	A	UNIT
PARAMETER	IESTO	CONDITIONS	MIN	typ‡	MAX	MIN	typ‡	MAX	UNIT
VIK	V _{CC} = 4.5 V,	II = -18 mA			-1.2			-1.2	V
VOH	$V_{CC} = 4.5 V \text{ to } 5.5 V,$	$I_{OH} = -2 \text{ mA}$	V _{CC} -2	2		V _{CC} -2	2		V
V _{OL}	V _{CC} = 4.5 V,	I _{OL} = 20 mA		0.35	0.5		0.35	0.5	V
Ц	V _{CC} = 5.5 V,	$V_{I} = 7 V$			0.1			0.1	mA
IIH	V _{CC} = 5.5 V,	V _I = 2.7 V			20			20	μΑ
١ _{١L}	V _{CC} = 5.5 V,	V _I = 0.4 V			-0.5			-0.5	mA
١ _O §	V _{CC} = 5.5 V,	V _O = 2.25 V	-30		-112	-30		-112	mA
ІССН	V _{CC} = 5.5 V,	$V_{I(A)} = 4.5 V, V_{I(B)} = 0$		11	18		11	18	mA
ICCL	V _{CC} = 5.5 V,	V _I = 4.5 V		20	38		20	38	mA

[‡] All typical values are at $V_{CC} = 5 V$, $T_A = 25^{\circ}C$.

§ The output conditions have been chosen to produce a current that closely approximates one half of the true short-circuit output current, IOS.

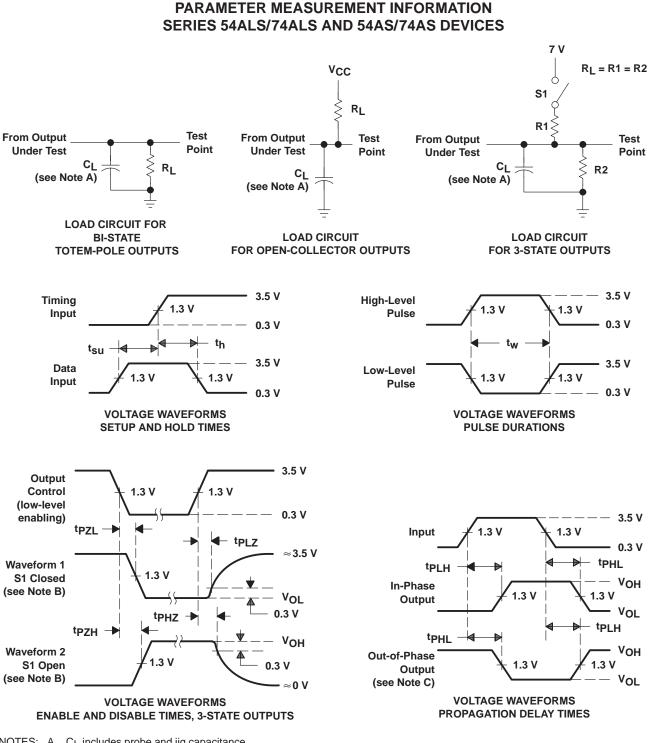
switching characteristics (see Figure 1)

PARAMETER	FROM TO (INPUT) (OUTPUT)		CL RL	= 50 pF = 500 Ω		V,	UNIT
				SN54AS86A		SN74AS86A	
				MAX	MIN	MAX	
^t PLH	A or B	V	2	8.5	2	7.5	
^t PHL	(other input low)	T	2	8	2	6.5	ns
^t PLH	A or B	V	1	8	1	6.5	
^t PHL	(other input high)	T	1	9	1	7	ns

 \P For conditions shown as MIN or MAX, use the appropriate value specified under recommended operating conditions.



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NOTES: A. CL includes probe and jig capacitance.

- B. Waveform 1 is for an output with internal conditions such that the output is low except when disabled by the output control. Waveform 2 is for an output with internal conditions such that the output is high except when disabled by the output control. C. When measuring propagation delay items of 3-state outputs, switch S1 is open.
- D. All input pulses have the following characteristics: $PRR \le 1$ MHz, $t_f = t_f = 2$ ns, duty cycle = 50%.
- E. The outputs are measured one at a time with one transition per measurement.

Figure 1. Load Circuits and Voltage Waveforms



28-Feb-2005

PACKAGING INFORMATION

Orderable Device	Status ⁽¹⁾	Package Type	Package Drawing	Pins	Package Qty	Eco Plan ⁽²⁾	Lead/Ball Finish	n MSL Peak Temp ⁽³⁾
5962-88621012A	ACTIVE	LCCC	FK	20	1	None	Call TI	Level-NC-NC-NC
5962-8862101CA	ACTIVE	CDIP	J	14	1	None	Call TI	Level-NC-NC-NC
5962-8862101DA	ACTIVE	CFP	W	14		None	Call TI	Level-NC-NC-NC
5962-9757201Q2A	ACTIVE	LCCC	FK	20	1	None	Call TI	Level-NC-NC-NC
5962-9757201QCA	ACTIVE	CDIP	J	14	1	None	Call TI	Level-NC-NC-NC
SN54ALS86J	ACTIVE	CDIP	J	14	1	None	Call TI	Level-NC-NC-NC
SN74ALS86D	ACTIVE	SOIC	D	14	50	Pb-Free (RoHS)	CU NIPDAU	Level-2-260C-1 YEAR/ Level-1-235C-UNLIM
SN74ALS86DR	ACTIVE	SOIC	D	14	2500	Pb-Free (RoHS)	CU NIPDAU	Level-2-260C-1 YEAR/ Level-1-235C-UNLIM
SN74ALS86N	ACTIVE	PDIP	Ν	14	25	Pb-Free (RoHS)	CU NIPDAU	Level-NC-NC-NC
SN74ALS86N3	OBSOLETE	PDIP	Ν	14		None	Call TI	Call TI
SN74ALS86NSR	ACTIVE	SO	NS	14	2000	Pb-Free (RoHS)	CU NIPDAU	Level-2-260C-1 YEAR/ Level-1-235C-UNLIM
SN74AS86AD	ACTIVE	SOIC	D	14	50	Pb-Free (RoHS)	CU NIPDAU	Level-2-260C-1 YEAR/ Level-1-235C-UNLIM
SN74AS86ADR	ACTIVE	SOIC	D	14	2500	Pb-Free (RoHS)	CU NIPDAU	Level-2-260C-1 YEAR/ Level-1-235C-UNLIM
SN74AS86AN	ACTIVE	PDIP	Ν	14	25	Pb-Free (RoHS)	CU NIPDAU	Level-NC-NC-NC
SNJ54ALS86FK	ACTIVE	LCCC	FK	20	1	None	Call TI	Level-NC-NC-NC
SNJ54ALS86J	ACTIVE	CDIP	J	14	1	None	Call TI	Level-NC-NC-NC
SNJ54ALS86W	OBSOLETE	CFP	W	14		None	Call TI	Level-NC-NC-NC
SNJ54AS86AFK	ACTIVE	LCCC	FK	20	1	None	Call TI	Level-NC-NC-NC
SNJ54AS86AJ	ACTIVE	CDIP	J	14	1	None	Call TI	Level-NC-NC-NC

⁽¹⁾ The marketing status values are defined as follows:

ACTIVE: Product device recommended for new designs.

LIFEBUY: TI has announced that the device will be discontinued, and a lifetime-buy period is in effect.

NRND: Not recommended for new designs. Device is in production to support existing customers, but TI does not recommend using this part in a new design.

PREVIEW: Device has been announced but is not in production. Samples may or may not be available.

OBSOLETE: TI has discontinued the production of the device.

⁽²⁾ Eco Plan - May not be currently available - please check http://www.ti.com/productcontent for the latest availability information and additional product content details.

None: Not yet available Lead (Pb-Free).

Pb-Free (RoHS): TI's terms "Lead-Free" or "Pb-Free" mean semiconductor products that are compatible with the current RoHS requirements for all 6 substances, including the requirement that lead not exceed 0.1% by weight in homogeneous materials. Where designed to be soldered at high temperatures, TI Pb-Free products are suitable for use in specified lead-free processes.

Green (RoHS & no Sb/Br): TI defines "Green" to mean "Pb-Free" and in addition, uses package materials that do not contain halogens, including bromine (Br) or antimony (Sb) above 0.1% of total product weight.

⁽³⁾ MSL, Peak Temp. -- The Moisture Sensitivity Level rating according to the JEDECindustry standard classifications, and peak solder temperature.

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PACKAGE OPTION ADDENDUM



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Mailing Address:

Texas Instruments

Post Office Box 655303 Dallas, Texas 75265

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